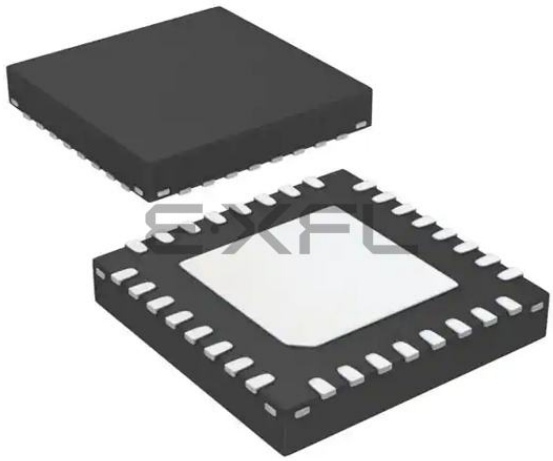
Lattice Semiconductor Corporation - ISPGAL22V10AV-75LNN Datasheet



Welcome to E-XFL.COM

Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	10
Number of Gates	-
Number of I/O	-
Operating Temperature	0°C ~ 75°C (TA)
Mounting Type	Surface Mount
Package / Case	32-VFQFN Exposed Pad
Supplier Device Package	32-QFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/ispgal22v10av-75lnn

ispGAL™22V10AV/B/C Device Datasheet

June 2010

All Devices Discontinued!

Product Change Notification (PCN) #09-10 has been issued to discontinue all devices in this data sheet.

The original datasheet pages have not been modified and do not reflect those changes. Please refer to the table below for reference PCN and current product status.

Product Line	Ordering Part Number	Product Status	Reference PCN
ispGAL22V10AV	ispGAL22V10AV-23LS	**Discontinued**	PCN#09-10
	ispGAL22V10AV-23LSN		
	ispGAL22V10AV-5LS		
	ispGAL22V10AV-5LSN		
	ispGAL22V10AV-75LS		
	ispGAL22V10AV-75LSN		
	ispGAL22V10AV-5LSI		
	ispGAL22V10AV-5LSNI		
	ispGAL22V10AV-75LSI		
	ispGAL22V10AV-75LSNI		
	ispGAL22V10AV-28LJ		
	ispGAL22V10AV-5LJ		
	ispGAL22V10AV-75LJ		
	ispGAL22V10AV-5LJI		
	ispGAL22V10AV-75LJI		
ispGAL22V10AB	ispGAL22V10AB-23LS	**Discontinued**	PCN#09-10
	ispGAL22V10AB-5LS		
	ispGAL22V10AB-75LS		
	ispGAL22V10AB-5LSI		
	ispGAL22V10AB-75LSI		
	ispGAL22V10AB-28LJ		
	ispGAL22V10AB-5LJ		
	ispGAL22V10AB-75LJ		
	ispGAL22V10AB-5LJI		
	ispGAL22V10AB-75LJI		

5555 N.E. Moore Ct. ● Hillsboro, Oregon 97124-6421 ● Phone (503) 268-8000 ● FAX (503) 268-8347
Internet: http://www.latticesemi.com

Product Line	Ordering Part Number	Product Status	Reference PCN
ispGAL22V10AC	ispGAL22V10AC-23LS	**Discontinued**	PCN#09-10
	ispGAL22V10AC-5LS		
	ispGAL22V10AC-75LS		
	ispGAL22V10AC-5LSI		
	ispGAL22V10AC-75LSI		
	ispGAL22V10AC-28LJ		
	ispGAL22V10AC-5LJ		
	ispGAL22V10AC-75LJ		
	ispGAL22V10AC-5LJI		
	ispGAL22V10AC-75LJI		

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Internet: http://www.latticesemi.com

ispGAL22V10AV/B/C

In-System Programmable Low Voltage E²CMOS® PLD Generic Array Logic

December 2008 — Data Sheet

Features

- **High Performance**
  - t_{PD} = 2.3ns propagation delay
  - f_{MAX} = 455 MHz maximum operating frequency
  - t_{CO} = 2ns maximum from clock input to data output
  - t_{SU} = 1.3 ns clock set-up time
- **Low Power**
  - 1.8V core E²CMOS® technology
  - Typical standby power <300µW (ispGAL22V10AC)
  - CMOS design techniques provide low static and dynamic power
- **Space-Saving Packaging**
  - Available in 32-pin QFNS (Quad Flat-pack, No lead, Saw-singulated) package 5mm x 5mm body size[1]
- **Easy System Integration**
  - Operation with 3.3V (ispGAL22V10AV), 2.5V (ispGAL22V10AB) or 1.8V (ispGAL22V10AC) supplies
  - Operation with 3.3V, 2.5V or 1.8V LVCMOS I/O
  - 5V tolerant I/O for LVCMOS 3.3 interface
  - Hot-socketing
  - Open-drain capability
  - Input pull-up, pull-down or bus-keeper
  - Lead-free package option
  - Programmable output slew rate
  - 3.3V PCI compatible
- **In-System Programmable**
  - IEEE 1149.1 boundary scan testable
  - 3.3V/2.5V/1.8V in-system programmable (ISP™) using IEEE 1532 compliant interface
- **E² CELL TECHNOLOGY**
  - In-system programmable logic
  - 100% tested/100% yields
  - High speed electrical erasure (<50ms)
- **Applications Include**
  - DMA control
  - State machine control
  - High speed graphics processing
  - Software-driven hardware configuration
- **Boundary Scan USERCODE Register**
  - Supports electronic signature

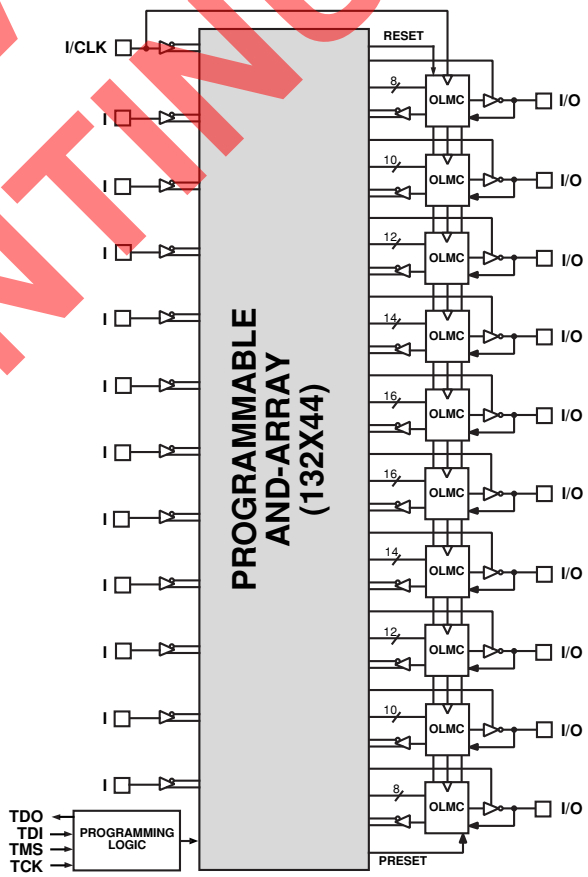
1. Use 32-pin QFNS package for all new designs. Refer to PCN #13A-08 for 32-pin QFN package discontinuance.

Introduction

The ispGAL22V10A is manufactured using Lattice Semiconductor's advanced E²CMOS process, which combines CMOS with Electrically Erasable (E^2) floating gate technology. With an advanced E^2 low-power cell and full CMOS logic approach, the ispGAL22V10A family offers fast pin-to-pin speeds, while simultaneously delivering low standby power without requiring any "turbo bits" or other traditional power management schemes. The ispGAL22V10A can interface with both 3.3V, 2.5V and 1.8V signal levels.

The ispGAL22V10A is functionally compatible with the ispGAL22LV10, GAL22LV10 and GAL22V10.

Figure 1. Functional Block Diagram



ispGAL Architecture

Output Logic Macrocell (OLMC)

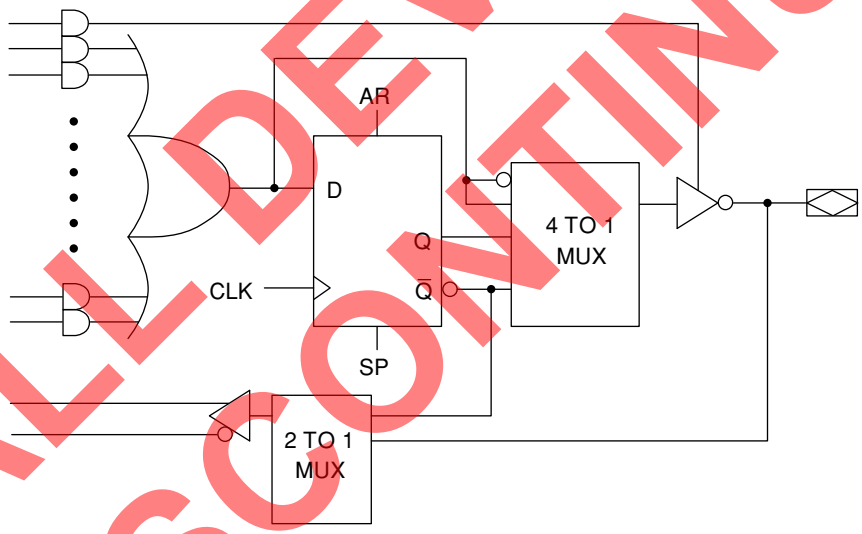
The ispGAL22V10A has a variable number of product terms per OLMC. Of the ten available OLMCs, two OLMCs have access to eight product terms (pins 17 and 27), two have ten product terms (pins 18 and 26), two have twelve product terms (pins 19 and 25), two have fourteen product terms (pins 20 and 24), and two OLMCs have sixteen product terms (pins 21 and 23). In addition to the product terms available for logic, each OLMC has an additional product-term dedicated to output enable control.

The output polarity of each OLMC can be individually programmed to be true or inverting, in either combinatorial or registered mode. This allows each output to be individually configured as either active high or active low.

The ispGAL22V10A has a product term for Asynchronous Reset (AR) and a product term for Synchronous Preset (SP). These two product terms are common to all registered OLMCs. The Asynchronous Reset sets all registers to zero any time this dedicated product term is asserted. The Synchronous Preset sets all registers to a logic one on the rising edge of the next clock pulse after this product term is asserted.

NOTE: The AR and SP product terms will force the Q output of the flip-flop into the same state regardless of the polarity of the output. Therefore, a reset operation, which sets the register output to a zero, may result in either a high or low at the output pin, depending on the pin polarity chosen.

Figure 2. Output Logic Macrocell



Output Logic Macrocell Configurations

Each of the Macrocells of the ispGAL22V10A has two primary functional modes: registered, and combinatorial I/O. The modes and the output polarity are set by two bits (S0 and S1), which are normally controlled by the logic compiler. Each of these two primary modes, and the bit settings required to enable them, are described below and on the following page.

Registered

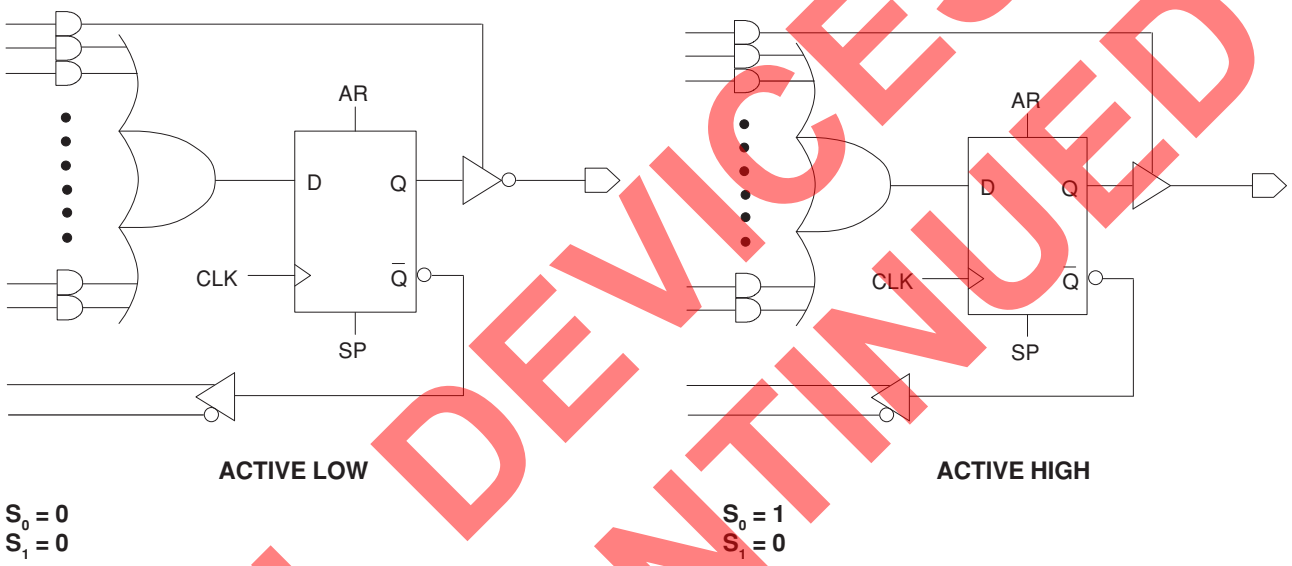
In registered mode the output pin associated with an individual OLMC is driven by the Q output of that OLMC's D-type flip-flop. Logic polarity of the output signal at the pin may be selected by specifying that the output buffer drive either true (active high) or inverted (active low). Output tri-state control is available as an individual product-term for each OLMC, and can therefore be defined by a logic equation. The D flip-flop's /Q output is fed back into the AND array, with both the true and complement of the feedback available as inputs to the AND array.

NOTE: In registered mode, the feedback is from the /Q output of the register, and not from the pin; therefore, a pin defined as registered is an output only, and cannot be used for dynamic I/O, as can the combinatorial pins.

Combinatorial I/O

In combinatorial mode the pin associated with an individual OLMC is driven by the output of the sum term gate. Logic polarity of the output signal at the pin may be selected by specifying that the output buffer drive either true (active high) or inverted (active low). Output tri-state control is available as an individual product-term for each output, and may be individually set by the compiler as either “on” (dedicated output), “off” (dedicated input), or “product-term driven” (dynamic I/O). Feedback into the AND array is from the pin side of the output enable buffer. Both polarities (true and inverted) of the pin are fed back into the AND array.

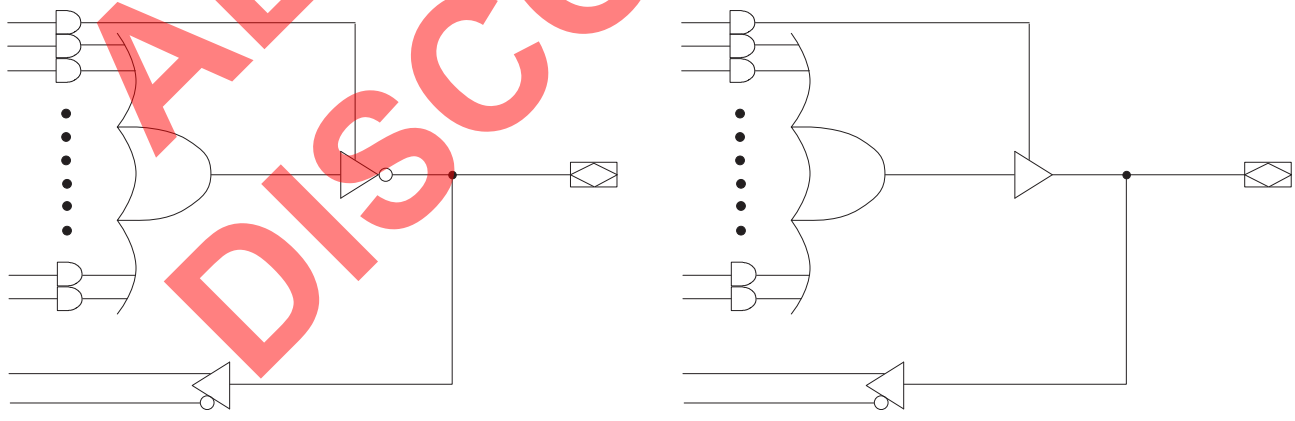
Figure 3. Registered Mode



ACTIVE LOW **ACTIVE HIGH**

$S_0 = 0$ $S_0 = 1$
$S_1 = 0$ $S_1 = 0$

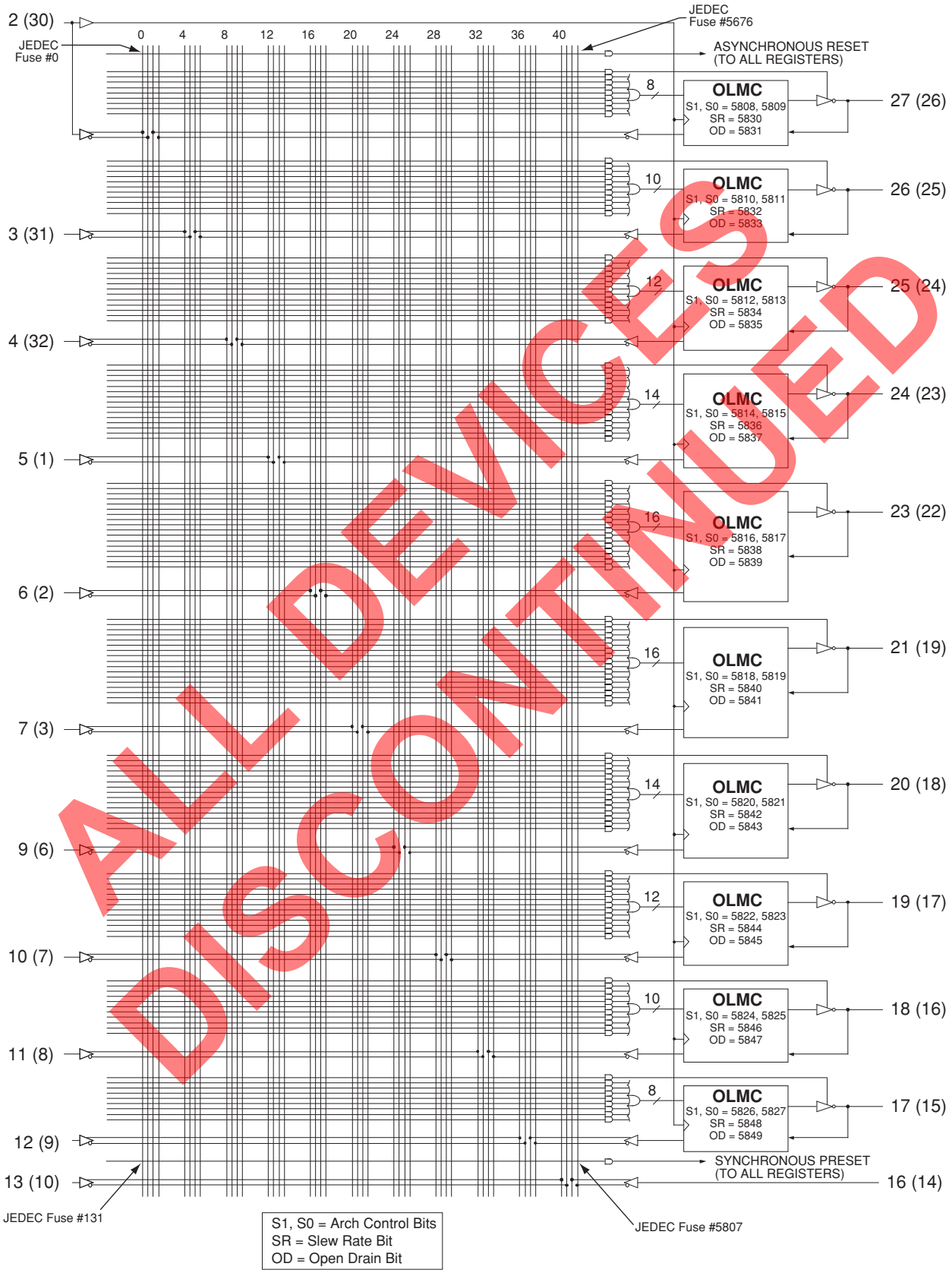
Figure 4. Combinatorial Mode



ACTIVE LOW **ACTIVE HIGH**

$S_0 = 0$ $S_0 = 1$
$S_1 = 1$ $S_1 = 1$

Figure 5. Logic Diagram/JEDEC Fuse Map – PLCC & (QFN/QFNS) Package Pinout



Electronic Signature

An electronic signature (ES) is provided in every ispGAL22V10A device. It contains 32 bits of reprogrammable memory that can contain user-defined data. Some uses include user ID codes, revision numbers, or inventory control. The signature data is always available to the user independent of the state of the security cell. IEEE 1149.1 and IEEE 1532 compliant USERCODE is supported.

Low Power and Power Management

The ispGAL22V10A family is designed with high speed low power design techniques to offer both high speed and low power. With an advanced E^2 low power cell and no sense-amplifiers (full CMOS logic approach), the ispGAL22V10A family offers fast pin-to-pin speeds, while simultaneously delivering low standby power without requiring any “turbo bits” or other traditional power-management schemes.

I/O Configuration

Each output supports a variety of output standards dependent on the V_{CCO}. Outputs can also be configured for open drain operation. Each input can be programmed to support a variety of standards, independent of the V_{CCO} supplied to its I/O. For 28 PLCC package the V_{CCO} and V_{CC} must be the same. The option to set the V_{CCO} independent of V_{CC} is available with the 32 QFN/QFNS package only. The I/O standards supported are:

- LVTTL
- LVCMOS 3.3
- LVCMOS 2.5
- LVCMOS 1.8
- 3.3V PCI Compatible

All of the I/Os and dedicated inputs have the capability to provide a bus-keeper latch, Pull-up Resistor or Pull-down Resistor. A fourth option is to provide none of these. The selection is done on a global basis. The default in both hardware and software is such that when the device is erased or if the user does not specify, the input structure is configured to be a Pull-up Resistor.

Each ispGAL22V10A device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for fast slew or slow slew. The typical edge rate difference between fast and slow slew setting is 20%. For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed.

IEEE 1149.1-Compliant Boundary Scan Testability

All ispGAL22V10A devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic notes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port operates with an LVCMOS interface that corresponds to the power supply voltage.

IEEE 1532-Compliant In-System Programming

Programming devices in-system provides a number of significant benefits including rapid prototyping, lower inventory levels, higher quality and the ability to make in-field modifications. All ispGAL22V10A devices provide In-System Programming (ISP™) capability through the Boundary Scan Test Access Port. This capability has been implemented in a manner that ensures that the port remains complaint to the IEEE 1149.1 standard. By using IEEE 1149.1 as the communication interface through which ISP is achieved, users get the benefit of a standard, well-defined interface. All ispGAL22V10A devices are also compliant with the IEEE 1532 standard.

The ispGAL22V10A devices can be programmed across the commercial temperature and voltage range. The PC-based Lattice software facilitates in-system programming of ispGAL22V10A devices. The software takes the JEDEC file output produced by the design implementation software, along with information about the scan chain, and creates a set of vectors used to drive the scan chain. The software can use these vectors to drive a scan chain

via the parallel port of a PC. Alternatively, the software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispGAL22V10A devices during the testing of a circuit board.

Security Bit

A programmable security bit is provided on the ispGAL22V10A devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit defeats readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. Programming and verification are also defeated by the security bit. The bit can only be reset by erasing the entire device.

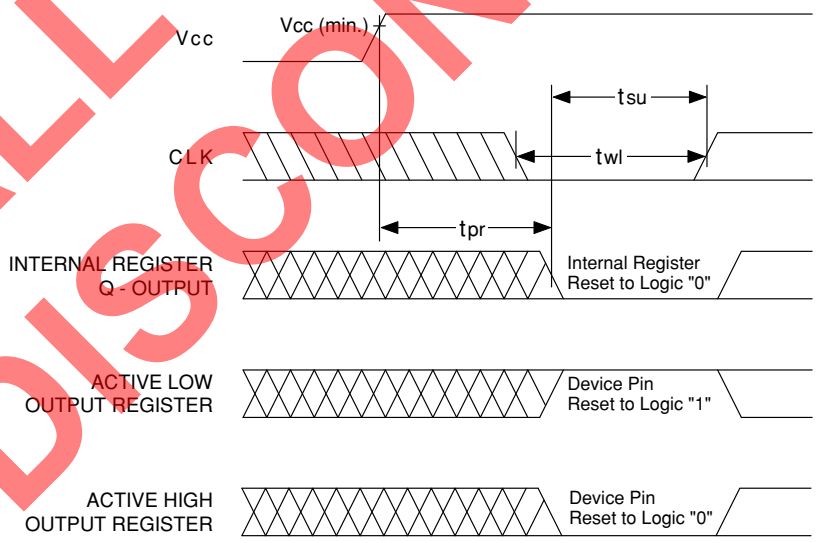
Hot Socketing

The ispGAL22V10A devices are well-suited for applications that require hot socketing. Hot socketing a device requires that the device, during power-up and down, tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of I/O pin loading be minimal on active signals. The ispGAL22V10A devices provide this capability for input voltages in the range of 0V to 3.0V.

Power-up Reset

Circuitry within the ispGAL22V10A provides a reset signal to all registers during power-up. All internal registers will have their Q outputs set low after a specified time (tpr, 1µs typical). As a result, the state on the registered output pins (if they are enabled) will be either high or low on power-up, depending on the programmed polarity of the output pins. This feature can greatly simplify state machine design by providing a known state on power-up. The timing diagram for power-up is shown above. Because of the asynchronous nature of system power-up, some conditions must be met to provide a valid power-up reset of the ispGAL22V10A. First, the Vcc rise must be monotonic. Second, the clock input must be at static TTL level as shown in the diagram during power up. The registers will reset within a maximum of tpr time. As in normal system operation, avoid clocking the device until all input and feedback path setup times have been met. The clock must also meet the minimum pulse width requirements.

Figure 6. Timing Diagram for Power-up



Absolute Maximum Ratings[1, 2, 3]

	ispGAL 22V10AC (1.8V)	ispGAL 22V10AB (2.5V)	ispGAL 22V10AV (3.3V)
Supply Voltage V_{CC}	-0.5 to 2.5V	-0.5 to 5.5V	-0.5 to 5.5V
Output Supply Voltage V_{CCO}	-0.5 to 4.5V	-0.5 to 4.5V	-0.5 to 4.5V
Input or I/O Tristate Voltage Applied[4]	-0.5 to 5.5V	-0.5 to 5.5V	-0.5 to 5.5V
Storage Temperature	-65 to 150°C	-65 to 150°C	-65 to 150°C
Junction Temperature (T_j) with Power Applied	-55 to 150°C	-55 to 150°C	-55 to 150°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with Lattice *Thermal Management* document is required.
3. All voltages referenced to GND.
4. Undershoot of -2V and overshoot of (V_{IH} (MAX) +2), up to a total pin voltage of 6.0V, is permitted for a duration of < 20ns.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
V_{CC}	Supply Voltage for 1.8V Devices	1.65	1.95	V
	Supply Voltage for 2.5V Devices	2.3	2.7	V
	Supply Voltage for 3.3V Devices	3.0	3.6	V
T_j	Junction Temperature (Commercial)	0	90	C
	Junction Temperature (Industrial)	-40	105	C

Erase Reprogram Specifications

Parameter	Min	Max	Units
Erase/Reprogram Cycle	1,000	—	Cycles

Note: Valid over commercial temperature range.

Hot Socketing Characteristics[1,2,3]

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{DK}	Input or I/O Leakage Current	$0 \le V_{IN} \le 3.0V$, $T_j = 105°C$	—	—	±50	µA

1. Insensitive to sequence of V_{CC} and V_{CCO}. However, assumes monotonic rise/fall rates for V_{CC} and V_{CCO}, provided (V_{IN} - V_{CCO}) ≤ 3.0V.
2. $0 \le V_{CC} \le V_{CC}$ (MAX), $0 \le V_{CCO} \le V_{CCO}$ (MAX)
3. I_{DK} is additive to I_{PU}, I_{PD} or I_{BH}. Device defaults to pull-up until fuse circuitry is active.

I/O Recommended Operating Conditions

Standard	V_{CCO} (V)[1] Min	Max
LVTTL	3.0	3.6
LVCMOS 3.3	3.0	3.6
LVCMOS 2.5	2.3	2.7
LVCMOS 1.8	1.65	1.95
PCI 3.3	3.0	3.6

1. Typical values for V_{CCO} are the average of the Min and Max values.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{IL}, I_{IH}[1]	Input Leakage Current	$0 < V_{IN} \leq 3.6V$, $T_j = 105°C$	—	—	10	µA
I_{IH}[2]	Input High Leakage Current	$3.6V < V_{IN} \leq 5.5V$, $T_j = 105°C$ $3.0V \leq V_{CCO} \leq 3.6V$	—	—	20	µA
I_{OS}	Output Short Circuit Current	$V_{CC} = 3.3V$, $V_{OUT} = 0.5V$, $T_A = 25°C$	—	—	-80	mA
I_{PU}	I/O Weak Pull-up Resistor Current	$0 \leq V_{IN} \leq 0.7V_{CCO}$	20	—	150	µA
I_{PD}	I/O Weak Pull-down Resistor Current	V_{IL} (MAX) $\leq V_{IN} \leq V_{IH}$ (MAX)	20	—	150	µA
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL}$ (MAX)	20	—	—	µA
I_{BHHS}	Bus Hold High Sustaining Current	$V_{IN} = 0.7\ V_{CCO}$	20	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive Current	$0V \leq V_{IN} \leq V_{IH}$ (MAX)	—	—	150	µA
I_{BHHO}	Bus Hold High Overdrive Current	$0 \leq V_{IN} \leq V_{IH}$ (MAX)	—	—	150	µA
V_{BHT}	Bus Hold Trip Points	—	V_{IL} (MAX)	—	V_{IH} (MIN)	V
C_1	I/O Capacitance[3]	$V_{CCO} = 3.3V, 2.5V, 1.8V$	—	6	—	pf
		$V_{CC} = 1.8V$, $V_{IO} = 0$ to V_{IH} (MAX)	—		—	
C_2	Clock Capacitance[3]	$V_{CCO} = 3.3V, 2.5V, 1.8V$	—	8	—	pf
		$V_{CC} = 1.8V$, $V_{IO} = 0$ to V_{IH} (MAX)	—		—	

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tristated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. 5 volt tolerant inputs and I/Os apply to V_{CCO} condition of $3.0V \leq V_{CCO} \leq 3.6V$.
3. $T_A = 25°C$, frequency = 1.0MHz

Supply Current

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min	Typ	Max	Units
ispGAL22V10AV/B/C						
I_{CC}[1, 2]	Operating Power Supply Current	$V_{CC} = 3.3V$	—	8	90	mA
		$V_{CC} = 2.5V$	—	8	90	mA
		$V_{CC} = 1.8V$	—	3	80	mA
I_{CC}[3]	Standby Power Supply Current	$V_{CC} = 3.3V$	—	7	—	mA
		$V_{CC} = 2.5V$	—	7	—	mA
		$V_{CC} = 1.8V$	—	150	—	µA

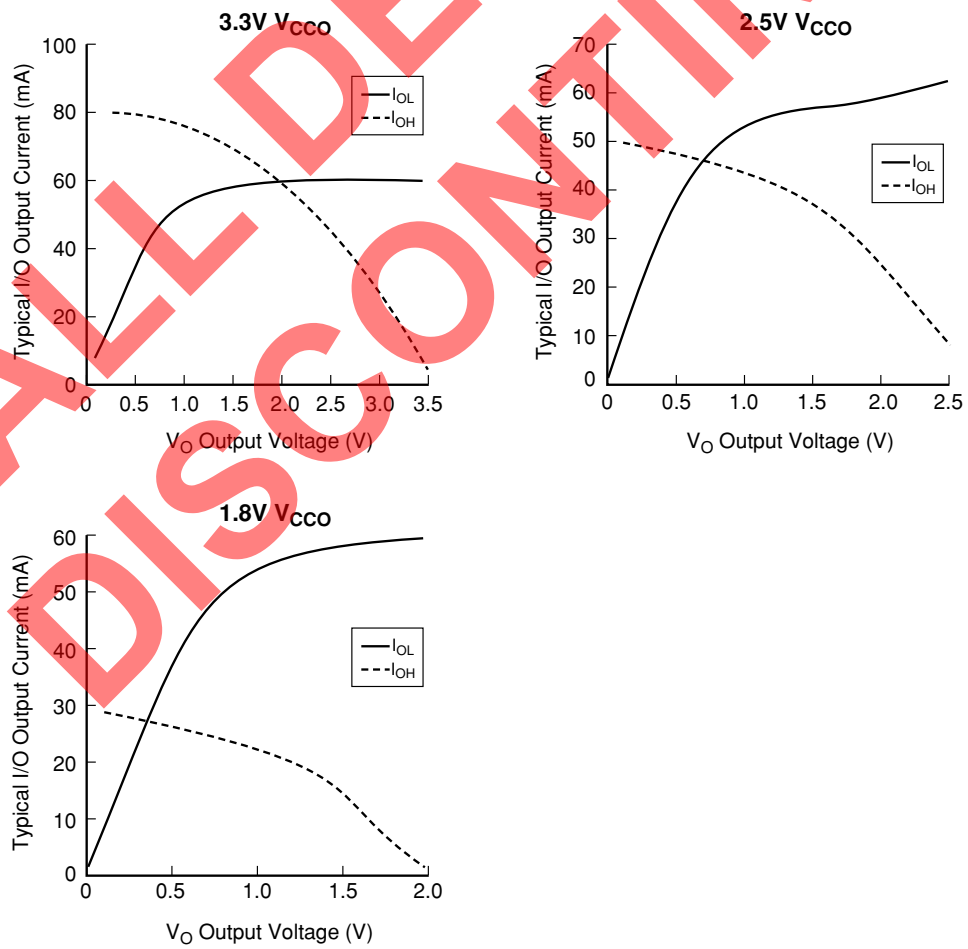
1. $T_A = 25°C$, frequency = 15MHz.
2. I_{CC} varies with specific device configuration and operating frequency.
3. $T_A = 25°C$

I/O DC Electrical Characteristics[1]

Over Recommended Operating Conditions

Standard	V_{IL}		V_{IH}		V_{OL} Max (V)	V_{OH} Min (V)	I_{OL} (mA)	I_{OH} (mA)
	Min (V)	Max (V)	Min (V)	Max (V)				
LVTTL	-0.3	0.80	2.0	5.5	0.40	V_{CCO} - 0.40	8.0	-4.0
					0.20	V_{CCO} - 0.20	0.1	-0.1
LVCMOS 3.3	-0.3	0.80	2.0	5.5	0.40	V_{CCO} - 0.40	8.0	-4.0
					0.20	V_{CCO} - 0.20	0.1	-0.1
LVCMOS 2.5	-0.3	0.70	1.70	3.6	0.40	V_{CCO} - 0.40	8.0	-4.0
					0.20	V_{CCO} - 0.20	0.1	-0.1
LVCMOS 1.8 (ispGAL22V10AV/B)	-0.3	0.63	1.17	3.6	0.40	V_{CCO} - 0.45	2.0	-2.0
					0.20	V_{CCO} - 0.20	0.1	-0.1
LVCMOS 1.8 (ispGAL22V10AC)	-0.3	0.35 V_{CC}	0.65 * V_{CC}	3.6	0.40	V_{CCO} - 0.45	2.0	-2.0
					0.20	V_{CCO} - 0.20	0.1	-0.1
PCI 3.3 (ispGAL22V10AV/B)	-0.3	1.08	1.5	5.5	0.1 V_{CCO}	0.9 V_{CCO}	1.5	-0.5
PCI 3.3 (ispGAL22V10AC)	-0.3	0.3 * 3.3 * (V_{CC} / 1.8)	0.5 * 3.3 * (V_{CC} / 1.8)	5.5	0.1 V_{CCO}	0.9 V_{CCO}	1.5	-0.5

1. For 28 PLCC package the I/O voltage and core voltage must be the same. The option to set the I/O voltage independent of the core voltage is available with the 32 QFN/QFNS package only.



ispGAL22V10AV/B/C External Switching Characteristics[1]

Over Recommended Operating Conditions

Param	Description	-23		-28		-5		-75		Units
		Min	Max	Min	Max	Min	Max	Min	Max	
t_{PD}	1 Output Switching Propagation Delay	—	2.3	—	2.8	—	—	—	—	ns
	10 Output Switching Propagation Delay	—	2.6	—	3.0	—	5.0	—	7.5	
t_{CO}	Clock to Output Delay	—	2.0	—	2.5	—	3.5	—	5.0	ns
t_{CF}[2]	Clock to Feedback Delay	—	1.9	—	2.2	—	2.5	—	2.5	ns
t_{SU}	Setup Time, Input or Feedback before CLK↑	1.3	—	2.0	—	3.5	—	5.0	—	ns
t_{H}	Hold Time, Input or Feedback after CLK↑	0	—	0	—	0	—	0	—	ns
f_{MAX}[3]	Maximum Clock Frequency with External Feedback, $[1/ (t_{SU} + t_{CO})]$	303	—	222	—	143	—	100	—	ns
	Maximum Clock Frequency with Internal Feedback, $[1/ (t_{SU} + t_{CF})]$	312	—	238	—	166	—	133	—	ns
	Maximum Clock Frequency with No Feedback	455	—	357	—	200	—	166	—	ns
t_{WH}[3]	Clock Pulse Duration, High	1.1	—	1.4	—	2.5	—	3.0	—	ns
t_{WL}[3]	Clock Pulse Duration, Low	1.1	—	1.4	—	2.5	—	3.0	—	ns
t_{EN}	Input or I/O to Output Enabled	—	3.0	—	3.5	—	6.0	—	7.5	ns
t_{DIS}	Input or I/O to Output Disabled	—	3.0	—	3.5	—	6.0	—	7.5	ns
t_{AR}	Input or I/O to Asynch, Reset of Reg.	—	2.8	—	3.5	—	5.5	—	9.0	ns
t_{ARW}	Asysnchronous Reset Pulse Duration	2.8	—	3.5	—	5.5	—	7.0	—	ns
t_{ARR}	Asysnchronous Reset to CLK↑ Recovery Time	2.5	—	3.0	—	4.0	—	5.0	—	ns
t_{SPR}	Synchronous Preset to CLK↑ Recovery Time	2.5	—	3.0	—	4.0	—	5.0	—	ns

1. Refer to Switching Test Conditions section.
2. Calculated from fmax with internal feedback. Refer to fmax Descriptions section.
3. Refer to fmax Descriptions section. Characterized but not 100% tested.

Note: Maximum clock input rise and fall time between 10% to 90% of Vout = 2ns.

ispGAL22V10AV/B/C Timing Adders

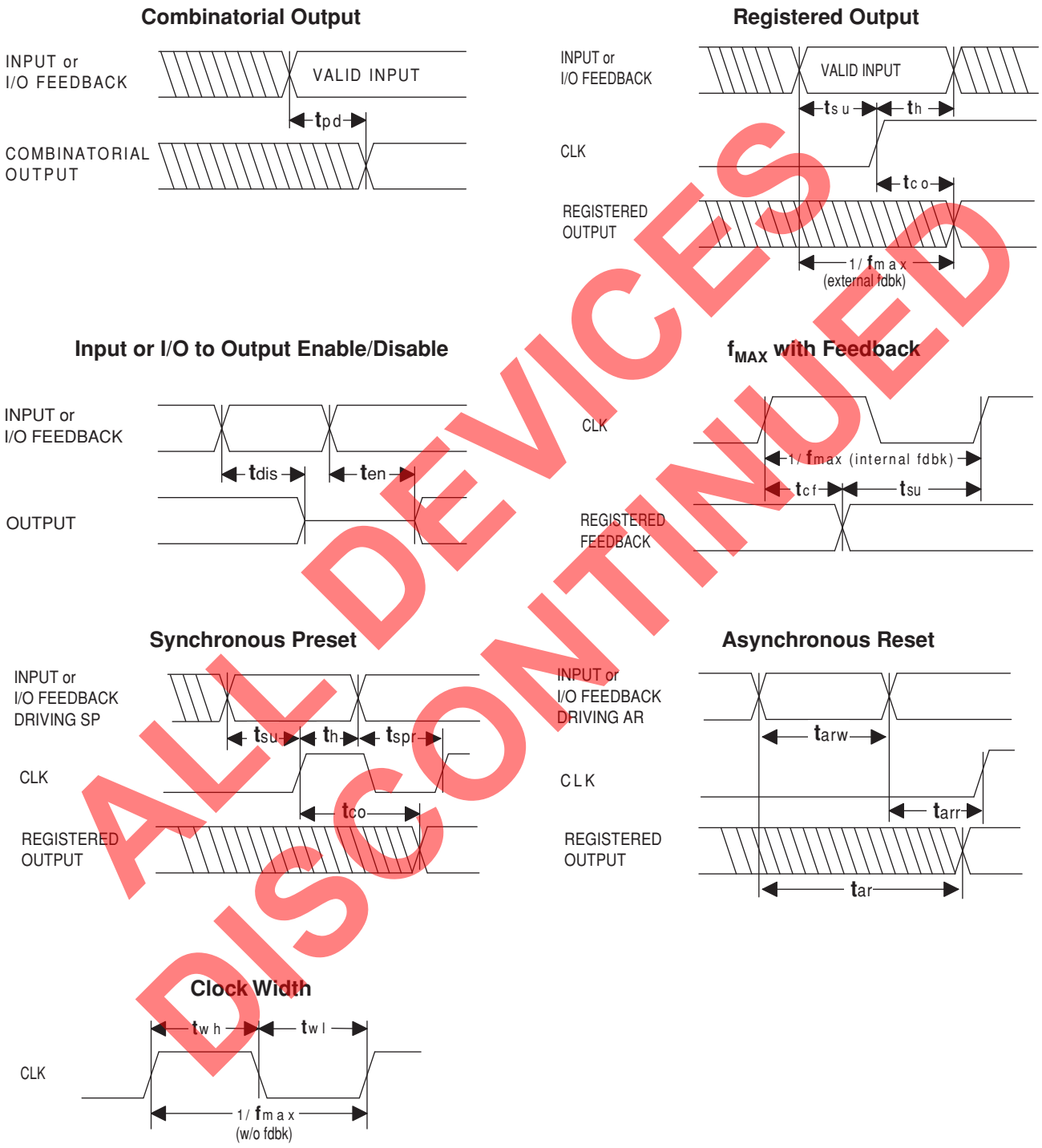
Over Recommended Operating Conditions

Adder Type	Description	-23		-28		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{IOI} Input Adjusters										
LVTTL_in	Using LVTTL standard	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVCMOS33_in	Using LVCMOS 3.3 standard	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVCMOS25_in	Using LVCMOS 2.5 standard	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVCMOS18_in	Using LVCMOS 1.8 standard	—	0	—	0	—	0	—	0	ns
PCI_in	Using PCI compatible input	—	0.6	—	0.6	—	0.6	—	0.6	ns
t_{IOO} Output Adjusters										
LVTTL_out	Output configured as TTL buffer	—	0.2	—	0.2	—	0.2	—	0.2	ns
LVCMOS33_out	Output configured as 3.3V buffer	—	0.2	—	0.2	—	0.2	—	0.2	ns
LVCMOS25_out	Output configured as 2.5V buffer	—	0.1	—	0.1	—	0.1	—	0.1	ns
LVCMOS18_out	Output configured as 1.8V buffer	—	0	—	0	—	0	—	0	ns
PCI_out	Output configured as PCI compatible buffer	—	0.2	—	0.2	—	0.2	—	0.2	ns
Slow Slew	Output configured for slow slew rate	—	1.0	—	1.0	—	1.0	—	1.0	ns

Note: Open drain timing is the same as corresponding LVCMOS timing.

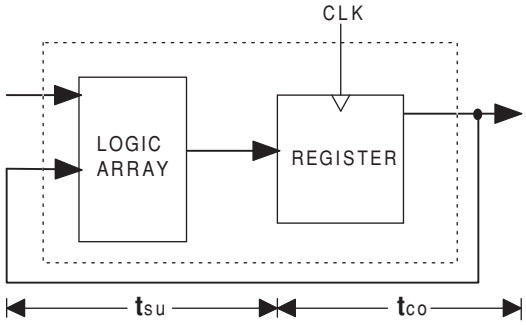
Switching Waveforms

Figure 7. ispGAL22V10AV/B/C Switching Waveforms



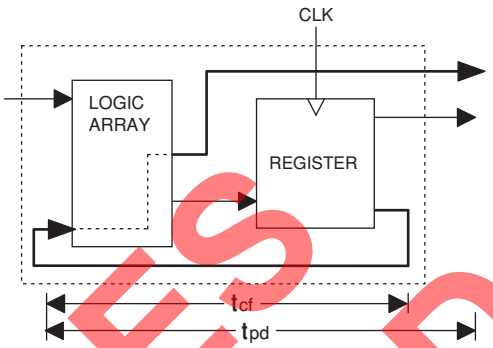
f_{MAX} Descriptions

Figure 8. ispGAL22V10AV/B/C f_{MAX} Descriptions



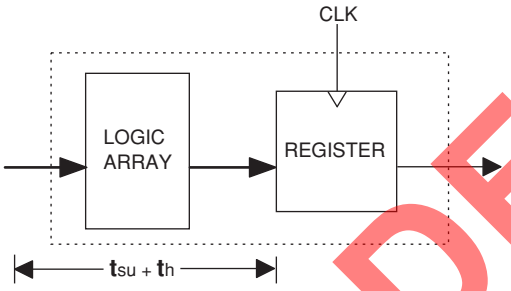
fmax with External Feedback 1/(tsu+tco)

Note: fmax with external feedback is calculated from measured tsu and tco.



fmax with Internal Feedback 1/(tsu+tcf)

Note: tcf is a calculated value, derived by subtracting tsu from the period of fmax w/internal feedback (tcf = 1/fmax - tsu). The value of tcf is used primarily when calculating the delay from clocking a register to a combinatorial output (through registered feedback), as shown above. For example, the timing from clock to a combinatorial output is equal to tcf + tpd.



fmax with No Feedback

Note: fmax with no feedback may be less than 1/twh + twl. This is to allow for a clock duty cycle of other than 50%.

Switching Test Conditions

Figure 9 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 1.

Figure 9. Output Test Load, LVTTL and LVCMOS Standards

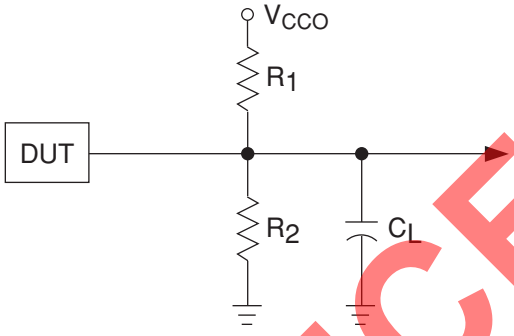


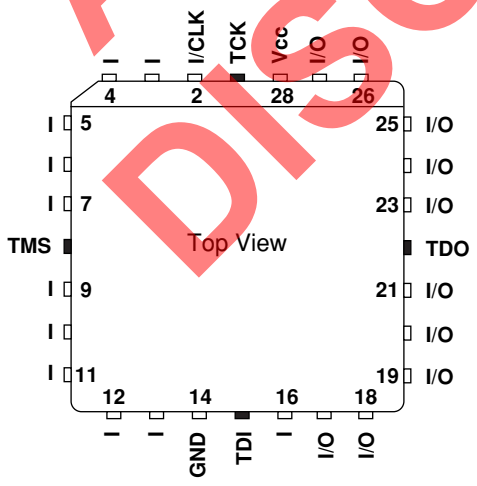
Table 1. Test Fixture Required Components

Test Condition	I/O Standard	R_1	R_2	C_L[1]	Input Timing Ref.[2]	Output Timing Ref.	V_{CCO}
LVCMOS I/O, (L -> H, H -> L)	LVCMOS 3.3	106Ω	106Ω	35pF	1.5V	1.5V	3.0V
	LVCMOS 2.5				1.2V	$V_{CCO}/2$	2.3V
	LVCMOS 1.8				(V/B) 0.9V	$V_{CCO}/2$	(V/B) 1.65V
					(C) $V_{CC}/2$	$V_{CCO}/2$	(C) V_{CC}
LVCMOS I/O (Z -> H)		106Ω	106Ω	35pF		Hi-Z + 0.3	3.0V
LVCMOS I/O (Z -> L)		106Ω	106Ω	35pF		Hi-Z - 0.3	3.0V
LVCMOS I/O (H -> Z)		∞	106Ω	5pF		V_{OH} - 0.3	3.0V
LVCMOS I/O (L -> Z)		106Ω	∞	5pF		V_{OL} + 0.3	3.0V

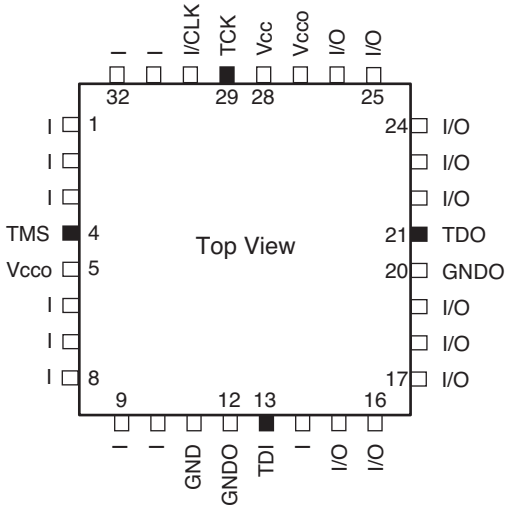
1. C_L includes test fixtures and probe capacitance.
2. Input conditions.

Pin Diagrams

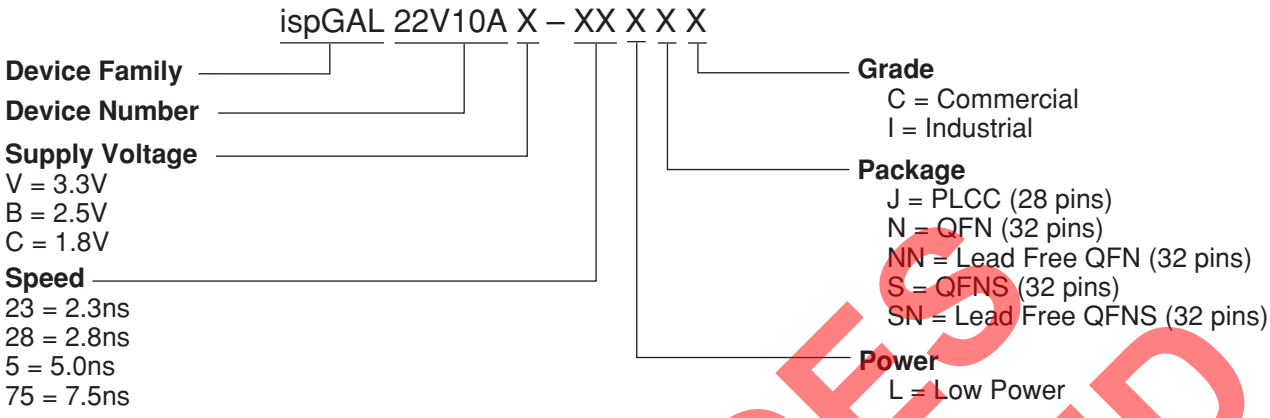
PLCC



QFN, QFNS



Part Number Description



Ordering Information

Conventional Packaging

Commercial

Part Number	Voltage	t_{PD}	Power	Package	Pin Count	Grade
ispGAL22V10AV-23LS	3.3	2.3ns	Low	QFNS	32	C
ispGAL22V10AV-23LN[1]	3.3	2.3ns	Low	QFN	32	C
ispGAL22V10AV-5LS	3.3	5.0ns	Low	QFNS	32	C
ispGAL22V10AV-5LN[1]	3.3	5.0ns	Low	QFN	32	C
ispGAL22V10AV-75LS	3.3	7.5ns	Low	QFNS	32	C
ispGAL22V10AV-75LN[1]	3.3	7.5ns	Low	QFN	32	C
ispGAL22V10AV-28LJ	3.3	2.8ns	Low	PLCC	28	C
ispGAL22V10AV-5LJ	3.3	5.0ns	Low	PLCC	28	C
ispGAL22V10AV-75LJ	3.3	7.5ns	Low	PLCC	28	C
ispGAL22V10AB-23LS	2.5	2.3ns	Low	QFNS	32	C
ispGAL22V10AB-23LN[1]	2.5	2.3ns	Low	QFN	32	C
ispGAL22V10AB-5LS	2.5	5.0ns	Low	QFNS	32	C
ispGAL22V10AB-5LN[1]	2.5	5.0ns	Low	QFN	32	C
ispGAL22V10AB-75LS	2.5	7.5ns	Low	QFNS	32	C
ispGAL22V10AB-75LN[1]	2.5	7.5ns	Low	QFN	32	C
ispGAL22V10AB-28LJ	2.5	2.8ns	Low	PLCC	28	C
ispGAL22V10AB-5LJ	2.5	5.0ns	Low	PLCC	28	C
ispGAL22V10AB-75LJ	2.5	7.5ns	Low	PLCC	28	C
ispGAL22V10AC-23LS	1.8	2.3ns	Low	QFNS	32	C
ispGAL22V10AC-23LN[1]	1.8	2.3ns	Low	QFN	32	C
ispGAL22V10AC-5LS	1.8	5.0ns	Low	QFNS	32	C
ispGAL22V10AC-5LN[1]	1.8	5.0ns	Low	QFN	32	C
ispGAL22V10AC-75LS	1.8	7.5ns	Low	QFNS	32	C
ispGAL22V10AC-75LN[1]	1.8	7.5ns	Low	QFN	32	C
ispGAL22V10AC-28LJ	1.8	2.8ns	Low	PLCC	28	C
ispGAL22V10AC-5LJ	1.8	5.0ns	Low	PLCC	28	C
ispGAL22V10AC-75LJ	1.8	7.5ns	Low	PLCC	28	C

1. Use QFNS package. QFN package devices have been discontinued via PCN #13A-08.

Industrial

Part Number	Voltage	t_{PD}	Power	Package	Pin Count	Grade
ispGAL22V10AV-5LSI	3.3	5.0ns	Low	QFNS	32	I
ispGAL22V10AV-5LNI[1]	3.3	5.0ns	Low	QFN	32	I
ispGAL22V10AV-75LSI	3.3	7.5ns	Low	QFNS	32	I
ispGAL22V10AV-75LNI[1]	3.3	7.5ns	Low	QFN	32	I
ispGAL22V10AV-5LJI	3.3	5.0ns	Low	PLCC	28	I
ispGAL22V10AV-75LJI	3.3	7.5ns	Low	PLCC	28	I
ispGAL22V10AB-5LSI	2.5	5.0ns	Low	QFNS	32	I
ispGAL22V10AB-5LNI[1]	2.5	5.0ns	Low	QFN	32	I
ispGAL22V10AB-75LSI	2.5	7.5ns	Low	QFNS	32	I
ispGAL22V10AB-75LNI[1]	2.5	7.5ns	Low	QFN	32	I
ispGAL22V10AB-5LJI	2.5	5.0ns	Low	PLCC	28	I
ispGAL22V10AB-75LJI	2.5	7.5ns	Low	PLCC	28	I
ispGAL22V10AC-5LSI	1.8	5.0ns	Low	QFNS	32	I
ispGAL22V10AC-5LNI[1]	1.8	5.0ns	Low	QFN	32	I
ispGAL22V10AC-75LSI	1.8	7.5ns	Low	QFNS	32	I
ispGAL22V10AC-75LNI[1]	1.8	7.5ns	Low	QFN	32	I
ispGAL22V10AC-5LJI	1.8	5.0ns	Low	PLCC	28	I
ispGAL22V10AC-75LJI	1.8	7.5ns	Low	PLCC	28	I

1. Use QFNS package. QFN package devices have been discontinued via PCN #13A-08.

Lead-Free Packaging

Commercial

Part Number	Voltage	t_{PD}	Power	Package	Pin Count	Grade
ispGAL22V10AV-23LSN	3.3	2.3ns	Low	QFNS	32	C
ispGAL22V10AV-23LNN[1]	3.3	2.3ns	Low	QFN	32	C
ispGAL22V10AV-5LSN	3.3	5.0ns	Low	QFNS	32	C
ispGAL22V10AV-5LNN[1]	3.3	5.0ns	Low	QFN	32	C
ispGAL22V10AV-75LSN	3.3	7.5ns	Low	QFNS	32	C
ispGAL22V10AV-75LNN[1]	3.3	7.5ns	Low	QFN	32	C

1. Use QFNS package. QFN package devices have been discontinued via PCN #13A-08.

Industrial

Part Number	Voltage	t_{PD}	Power	Package	Pin Count	Grade
ispGAL22V10AV-5LSNI	3.3	5.0ns	Low	QFNS	32	I
ispGAL22V10AV-5LNNI[1]	3.3	5.0ns	Low	QFN	32	I
ispGAL22V10AV-75LSNI	3.3	7.5ns	Low	QFNS	32	I
ispGAL22V10AV-75LNNI[1]	3.3	7.5ns	Low	QFN	32	I

1. Use QFNS package. QFN package devices have been discontinued via PCN #13A-08.

Note: For all but the slowest commercial speed grade, the speed grades on these devices are dual marked. For example, the commercial speed grade -5LJ is also marked with the industrial grade -7LJI. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade is marked as commercial grade only.

Revision History

Date	Version	Change Summary
—	—	Previous Lattice releases.
December 2008	03.0	Added 32-pin QFNS package Ordering Part Number information per PCN #13A-08.